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PTO/SB/21 (09-04) Approved for use through 07/31/2006. OMB 0651-0031
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o a collection of information unless it displays a valid OMB control number. rwork Reduction Act of 1995, no persons are required to respond to a c Application Number 10/711,883 Filing Date TRANSMITTAL 10/12/2004 First Named Inventor **FORM** Chen-Hsiung Yang Art Unit **Examiner Name** (to be used for all correspondence after initial filing) Attorney Docket Number TMIP0003USA Total Number of Pages in This Submission **ENCLOSURES** (Check all that apply) After Allowance Communication to TC ~ Fee Transmittal Form Drawing(s) Appeal Communication to Board Licensing-related Papers Fee Attached of Appeals and Interferences Appeal Communication to TC Amendment/Reply (Appeal Notice, Brief, Reply Brief) Petition to Convert to a Proprietary Information After Final Provisional Application Power of Attorney, Revocation Status Letter Affidavits/declaration(s) Change of Correspondence Address Other Enclosure(s) (please Identify Terminal Disclaimer **Extension of Time Request** Request for Refund Express Abandonment Request CD, Number of CD(s) Information Disclosure Statement Landscape Table on CD Certified Copy of Priority Remarks ~ Document(s) Reply to Missing Parts/ Incomplete Application Reply to Missing Parts under 37 CFR 1.52 or 1.53 SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT

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Reg. No.

North America Intellectual Property Corp.

Mundon

Winston Hsu

10/14/2004

Firm Name

Signature

Date

Printed name

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PTO/SB/17 (10-04)
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Complete if Known FEE TRANSMITTAL 10/711.883 Application Number 10/12/2004 Filing Date for FY 2005 Chen-Hsiung Yang First Named Inventor Effective 10/01/2004. Patent fees are subject to annual revision. **Examiner Name** Applicant claims small entity status. See 37 CFR 1.27 Art Unit (\$) 0.00 TOTAL AMOUNT OF PAYMENT Attorney Docket No. TMIP0003USA

| METUOD OF DAVMENT (About All the second) | | | |
|--|--|--|--|
| METHOD OF PAYMENT (check all that apply) | FEE CALCULATION (continued) | | |
| Check Credit card Money Other None | 3. ADDITIONAL FEES | | |
| Deposit Account: | Large Entity Small Entity Fee | | |
| Deposit Account 50-3105 | Code (\$) Code (\$) Fee Description | | |
| Account 50-3105 Number | 1051 130 2051 65 Surcharge - late filing fee or oath | | |
| Deposit Account North America Intellectual Property Corp. | 1052 50 2052 25 Surcharge - late provisional filing fee or cover sheet | | |
| Name The Director is authorized to: (check all that apply) | 1053 130 1053 130 Non-English specification | | |
| Charge fee(s) indicated below Credit any overpayments | 1812 2,520 1812 2,520 For filing a request for ex parte reexamination | | |
| Charge any additional fee(s) or any underpayment of fee(s) | 1804 920* 1804 920* Requesting publication of SIR prior to Examiner action | | |
| Charge fee(s) indicated below, except for the filing fee | 1805 1,840* 1805 1,840* Requesting publication of SIR after | | |
| to the above-identified deposit account. | Examiner action | | |
| FEE CALCULATION | 1251 110 2251 55 Extension for reply within first month | | |
| 1. BASIC FILING FEE | 1252 430 2252 215 Extension for reply within second month | | |
| Large Entity Small Entity Fee Fee Fee Fee Fee Description Fee Paid | 1253 980 2253 490 Extension for reply within third month | | |
| Code (\$) Code (\$) | 1254 1,530 2254 765 Extension for reply within fourth month | | |
| 1001 790 2001 395 Utility filing fee | 1255 2,080 2255 1,040 Extension for reply within fifth month | | |
| 1002 350 2002 175 Design filing fee | 1401 340 2401 170 Notice of Appeal | | |
| 1003 550 2003 275 Plant filing fee | 1402 340 2402 170 Filing a brief in support of an appeal | | |
| 1004 790 2004 395 Reissue filing fee | 1403 300 2403 150 Request for oral hearing | | |
| 1005 160 2005 80 Provisional filing fee | 1451 1,510 1451 1,510 Petition to institute a public use proceeding | | |
| SUBTOTAL (1) (\$) 0.00 | 1452 110 2452 55 Petition to revive - unavoidable | | |
| 2. EXTRA CLAIM FEES FOR UTILITY AND REISSUE | 1453 1,330 2453 665 Petition to revive - unintentional | | |
| Fee from | 1501 1,370 2501 685 Utility issue fee (or reissue) | | |
| Extra Claims below Fee Paid Total Claims -20** = X = | | | |
| Independent 3** - V | 1503 660 2503 330 Plant issue fee | | |
| Claims — — — — — — — — — — — — — — — — — — — | 1460 130 1460 130 Petitions to the Commissioner | | |
| Lance February Court Forth | 1807 50 1807 50 Processing fee under 37 CFR 1.17(q) | | |
| Large Entity Small Entity Fee Fee Fee Fee Fee Description | 1806 180 1806 180 Submission of Information Disclosure Stmt | | |
| Code (\$) Code (\$) 1202 18 2202 9 Claims in excess of 20 | 8021 40 8021 40 Recording each patent assignment per property (times number of properties) | | |
| 1202 16 2202 9 Claims in excess 0120 1201 88 2201 44 Independent claims in excess of 3 | 1809 790 2809 395 Filing a submission after final rejection (37 CFR 1.129(a)) | | |
| 1203 300 2203 150 Multiple dependent claim, if not paid | 1810 790 2810 395 For each additional invention to be | | |
| 1204 88 2204 44 ** Reissue independent claims over original patent | examined (37 CFR 1.129(b)) 1801 790 2801 395 Request for Continued Examination (RCE) | | |
| 1205 18 2205 9 ** Reissue claims in excess of 20 and over original patent | 1802 900 1802 900 Request for expedited examination of a design application | | |
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| SUBTOTAL (2) (\$) 0.00 | *Reduced by Basic Filing Fee Paid SUBTOTAL (3) (\$) 0.00 | | |

SUBMITTED BY (Complete (if applicable))

Name (Prin/Type) Winston Hsu Registration No. (Altomey/Agent) 41,526 Telephone 886289237350

Signature Date 10/14/2004

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De Included on this form. Provide credit card information and authorization on P10-2038.

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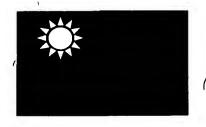
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DECLARATION – Supplemental Priority Data Sheet

| Foreign applications: | | | | | |
|--|---------------|-------------------------------------|-------------------------|----------------------|-------------------|
| Prior Foreign Application Number(s) | Country | Foreign Filing Date (MM/DD/YYYY) | Priority Not Claimed | Certified Cop YES | y Attached? NO |
| 093122940 | Taiwan R.O.C. | 7/30/2004 | | V | |
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일만 되면 되면

中華民國經濟部智慧財產局

INTELLECTUAL PROPERTY OFFICE MINISTRY OF ECONOMIC AFFAIRS REPUBLIC OF CHINA

茲證明所附文件,係本局存檔中原申請案的副本,正確無訛, 其申請資料如下:

This is to certify that annexed is a true copy from the records of this office of the application as originally filed which is identified hereunder

西元 2004 年 07 月 30

Application Date

(號:: 093122940

Application No. (

探微科技股份有限公司

Applicant(s)

Director General

CERTIFIED COPY OF PRIORITY DOCUMENT

發文日期: 西元 2004年 8 月

Issue Date

發文字號: Serial No.

09320760550

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發明專利說明書

(本說明書格式、順序及粗體字,請勿任意更動,※記號部分請勿填寫)

※申請案號:

※申請日期:

※IPC 分類:

一、發明名稱:(中文/英文)

雙面蝕刻晶圓之方法 /

METHOD OF DOUBLE-SIDED ETCHING

二、申請人:(共1人)

姓名或名稱:(中文/英文)

探微科技股份有限公司 / TOUCH MICRO-SYSTEM TECHNOLOGY INC

代表人:(中文/英文)

李家弘 / LEE、XAVIER C.H.

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國籍:(中文/英文)

中華民國 / TWN

三、發明人:(共1人)

姓 名:(中文/英文)

1. 楊辰雄 / YANG, CHEN-HSIUNG

國籍:(中文/英文)

1. 中華民國 / TWN

| 四、聲明事項: |
|----------------------------------|
| □ 主張專利法第二十二條第二項□第一款或□第二款規定之事實,其 |
| 事實發生日期為: 年 月 日。 |
| □ 申請前已向下列國家(地區)申請專利: |
| 【格式請依:受理國家(地區)、申請日、申請案號,順序註記】 |
| □ 有主張專利法第二十七條第一項國際優先權: |
| |
| |
| □ 無主張專利法第二十七條第一項國際優先權: |
| |
| · |
| □ 主張專利法第二十九條第一項國內優先權: |
| 【格式請依:申請日、申請案號 順序註記】 |
| · · · |
| 主張專利法第三十條生物材料: |
| □ 須寄存生物材料者: |
| 國內生物材料 【格式請依:寄存機構、日期、號碼 順序註記】 |
| |
| 國外生物材料 【格式請依:寄存國家、機構、日期、號碼 順序註記】 |
| |
| □ 不須寄存生物材料者: |
| 所屬技術領域中具有通常知識者易於獲得時,不須寄存。 |

五、中文發明摘要:

首先,提供一晶圓,該晶圓包含有至少一旋轉軸區與至少二穿透區,且該二穿透區係位於該旋轉軸區之二側。接著由該晶圓之一底表面去除部分位於該旋轉軸區之該晶圓。隨後將該晶圓之底表面利用一黏著層黏貼於一負載載具上,並由該晶圓之上表面去除位於該二穿透區之該晶圓直至穿透該晶圓。

六、英文發明摘要:

A wafer, having at least a spindle region and at least two through regions alongside the spindle region, is provided. The wafer in the spindle region is partially removed from the bottom surface. Thereafter, the bottom surface is bonded to a carrier with a bonding layer, and the wafer in the through regions is completely removed from the top surface.

七、指定代表圖:

- (一)本案指定代表圖為:第(7)圖。
- (二)本代表圖之元件代表符號簡單說明:

| 50 | 昌圓 | 54 | 旋轉軸區 |
|----|------|----|------|
| 56 | 黏著層 | 58 | 負載載具 |
| 60 | 光阻圖案 | 62 | 穿透區 |

八、本案若有化學式時,請揭示最能顯示發明特徵的化學式:

無

九、發明說明:

【發明所屬之技術領域】

本發明係關於一種雙面蝕刻晶圓之方法,尤指一種利用 雙面蝕刻製程製作微旋轉軸之方法。

【先前技術】

微機電(micro electro mechanical system, MEMS)技術係為一種高度整合電子電路與機械等之新興科技,並已廣泛地被應用於製作各種具有電子與機械雙重特性之元件,例如微感應器、微致動器、微馬達與光開關元件等。相較於半導體元件,微機電元件由於常具有特殊的機械結構,因此於製作時若直接利用標準半導體製程,所形成之結構往往精密度不佳,而無法達到微機電元件之要求。其中微旋轉軸為微機電元件中常見之結構,且由於旋轉軸之形狀與表面狀態對於旋轉軸時對於形狀與表面狀態的要求特別嚴格。

請參考第1圖至第3圖,第1圖為一微旋轉軸10之示

意圖,而第2圖與第3圖為習知製作微旋轉軸之方法示意圖。如第1圖所示,微旋轉軸10具有一懸吊結構,並可受電壓、光線或磁場等之驅動而依第1圖中之箭號所示之方向旋轉,因此微旋轉軸10之形狀必須極為精確,並具有平滑之表面以及均勻的軸體,方可確保可靠度並達到對應力承受之要求。習知製作微旋轉軸10之方法如下所述。

如第2圖所示,首先提供一晶圓20,並於分別於晶圓20之底表面與上表面形成一蝕刻停止層22與一光阻圖案24。如第3圖所示,接著進行一蝕刻製程,利用光阻圖案24作為一硬遮罩,以去除未被光阻圖案24保護之晶圓20直至蝕穿晶圓20,並停止於蝕刻停止層22。

然而,習知方法於蝕穿晶圓 20 的過程中,未考慮蝕刻均勻度與晶圓 20 厚度之均勻度對蝕刻速率之影響,因此蝕刻製程的良率容易因為晶圓 20 之各區域的蝕刻速率不同而無法有效控制。舉例來說,當蝕刻製程進行到最後階段即將蝕穿晶圓 20 之際,蝕刻總面積將產生劇烈變化而導致蝕刻製程產生無法預期之變化。除此之外,當蝕刻至蝕刻停止層 22 時,極易發生側蝕現象而產生如第 3 圖所示之底切 26,進而影響微旋轉軸的結構。如前所述,一旦微旋轉

軸之形狀的精密度不佳,即會嚴重影響微旋轉軸之可靠度。

有鑑於此,申請人乃根據此等缺點及依據多年之相關經驗,悉心觀察且研究之,而提出改良之本發明,以提升微旋轉軸之可靠度與良率。

【發明內容】

因此,本發明之主要目的在提供一種雙面蝕刻晶圓之方法,以改善習知技術無法克服之難題。

根據本發明之一較佳實施例,係提供一種製作微旋轉軸之方法。首先,提供一晶圓,該晶圓包含有至少一旋轉軸區與至少二穿透區,且該二穿透區係位於該旋轉軸區之二側。接著由該晶圓之一底表面去除部分位於該旋轉軸區之該晶圓。隨後將該晶圓之底表面利用一黏著層黏貼於一負載載具上,並由該晶圓之上表面去除位於該二穿透區之該晶圓直至穿透該晶圓。

由於本發明之方法利用雙面蝕刻方式來製作微旋轉軸結構,可有效避免於蝕刻製程中蝕刻總面積變化過大造成

蝕刻結果不易控制,以及蝕刻至蝕刻停止層時易發生之側 蝕問題,因此可確保微旋轉軸具有良好結構,進而提升微 旋轉軸的可靠度與可承受之應力。

為了使 貴審查委員能更近一步了解本發明之特徵及技術內容,請參閱以下有關本發明之詳細說明與附圖。然而所附圖式僅供參考與輔助說明用,並非用來對本發明加以限制者。

【實施方式】

請參考第4圖至第8圖,第4圖至第8圖為本發明之一較佳實施例製作微旋轉軸之方法示意圖。如第4圖所示,首先提供一晶圓50,例如一矽晶圓,並於晶圓50之底表面形成一光阻圖案52,以定義出一旋轉軸區54之位置。如第5圖所示,接著進行一蝕刻製程,例如一反應性離子蝕刻(reactive ion etching, RIE),利用光阻圖案52作為一硬遮罩,去除位於旋轉軸區54之晶圓50至一預定深度。其中上述預定深度必須大於後續由晶圓50之上表面進行之另一蝕刻製程之變異量與晶圓50厚度之變異量之總和,以避免微旋轉軸之結構於後續蝕刻製程中損壞。

如第6圖所示,接著去除光阻圖案(圖未示),並利用一黏著層 56 將晶圓 50 之底表面接合於一負載載具 58 上。隨後再於晶圓 50 之上表面形成另一光阻圖案 60,以定義出二穿透區 62 之位置。其中黏著層 56 可選用光阻、金屬、二氧化矽、苯環丁烯(Benzocyclobutene, BCB)、聚亞醯胺(polyimide)、二氧化矽、金屬、膠帶、UV 膠帶或臘等可利用溼蝕刻、加熱或照光方式去除之材質。負載載具 58 則可為矽、玻璃、石英或陶瓷等相容於半導體製程之材質。

如第7圖,接著進行另一蝕刻製程,例如一反應性離子蝕刻製程,利用光阻圖案 60 作為一硬遮罩,去除位於穿透區 62 內之晶圓 50。其中當蝕刻製程進行至第7圖所示之深度時,位於旋轉軸區 54 之晶圓會呈現懸浮狀態,而此時蝕刻總面積之最大變化量僅為穿透區 62 內之晶圓面積扣除旋轉軸區 54 內之晶圓面積,因此蝕刻總面積並不會產生劇烈變化而使蝕刻製程產生無法預期之變化。除此之外,由於此時尚未蝕刻至黏著層 56,因此位於旋轉軸區 54 內之晶圓 50 亦不會產生側蝕的現象。另外,於本實施例中第一次蝕刻製程中之光阻圖案(圖未示)所定義出之旋轉軸區之尺寸係略大於微旋轉軸之實際尺寸,藉此可增加第二次蝕刻製程之定位容忍度,藉此後續形成之微旋轉軸之形狀

如第8圖所示,繼續進行蝕刻製程直至蝕穿位於穿透區62內之晶圓50為止,並將晶圓50上表面之光阻圖案60與下表面之黏著層56移除即完成微旋轉軸之製作。值得注意的是黏著層56除了黏著晶圓50與負載載具58之功能外,亦具有蝕刻停止層之功能,當蝕刻進行至黏著層56時,蝕刻總面積會產生較大之變化,並有可能產生側蝕現象,然而由於位於旋轉軸區54內之晶圓50係呈懸浮狀態,且於第一次蝕刻製程之變異量與晶圓50厚度之變異量考慮在內,因此旋轉軸區54內之晶圓50不會受到影響。換句話說,微旋轉軸的結構不會受到蝕刻製程之變異量的影響,而具有如原先預期之形狀,因此具有良好的可靠度。

相較於習知技術,本發明之方法利用雙面蝕刻方式來製作微旋轉軸結構,可有效避免於蝕刻製程中蝕刻總面積變 化過大造成蝕刻結果不易控制,以及蝕刻至蝕刻停止層時 易發生之側蝕問題,因此可確保微旋轉軸具有良好結構, 進而提升微旋轉軸的可靠度與可承受之應力。 以上所述僅為本發明之較佳實施例,凡依本發明申請專利範圍所做之均等變化與修飾,皆應屬本發明專利之涵蓋範圍。

【圖式簡單說明】

第1圖為一微旋轉軸之示意圖。

第2圖與第3圖為習知製作微旋轉軸之方法示意圖。

第 4 圖至第 8 圖為本發明之一較佳實施例製作微旋轉軸之 方法示意圖。

【主要元件符號說明】

| 10 | 微旋轉軸 | 20 | 晶圓 |
|----|-------|----|------|
| 22 | 蝕刻停止層 | 24 | 光阻圖案 |
| 26 | 底切 | 50 | 昌圓 |
| 52 | 光阻圖案 | 54 | 旋轉軸區 |
| 56 | 黏著層 | 58 | 負載載具 |
| 60 | 光阻圖案 | 62 | 穿透區 |

十、申請專利範圍:

1. 一種雙面蝕刻晶圓之方法,其包含有:

提供一晶圓,該晶圓包含有至少一第一區域與至少一第二區域,該第一區域之面積小於該第二區域之面積,且該第二區域係部分重疊於該第一區域;

進行一第一黃光暨蝕刻製程,由該晶圓之一第一表面去除位於該第一區域之該晶圓至一預定深度;

將該晶圓之該第一表面貼附於一負載載具上;

進行一第二黃光暨蝕刻製程,由該晶圓之一第二表面去除位於該第二區域但不包含位於該第一區域之該 晶圓直至蝕穿該晶圓。

- 如申請專利範圍第1項所述之方法,其中該第一區域與 該第二區域係用以定義一微旋轉軸結構。
- 如申請專利範圍第1項所述之方法,其中該第一黃光暨 蝕刻製程包含有:

由該第一表面蝕刻未被該第一光阻圖案覆蓋之該晶圓

至該預定深度,且該預定深度大於後續進行之該第二黃光暨蝕刻製程之變異量與該晶圓厚度之變異量之總和;以及

去除該第一光阻圖案。

- 如申請專利範圍第1項所述之方法,其中該晶圓之該第 一表面係利用一黏著層貼附於該負載載具上。
- 5. 如申請專利範圍第1項所述之方法,其中該第二黃光暨 蝕刻製程包含有:

於該晶圓之該第二表面形成一第二光阻圖案,且該第二 光阻圖案曝露出未與該第一區域重疊之該第二區 域;

由該第二表面蝕穿未被該第二光阻圖案覆蓋之該晶圓,並停止於該黏著層;以及去除該第二光阻圖案。

- 6. 如申請專利範圍第1項所述之方法,另包含有於該第二 黃光暨蝕刻製程後進行一移除該黏著層之步驟。
- 7. 一種製作微旋轉軸之方法,其包含有:

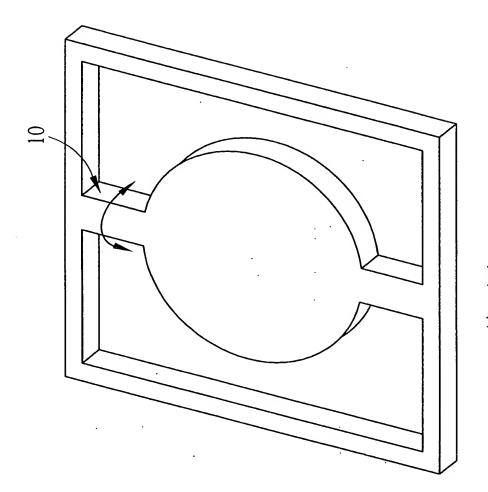
提供一晶圓,該晶圓包含有至少一旋轉軸區與至少二穿透區,且該二穿透區係位於該旋轉軸區之二側;

由該晶圓之一第一表面去除部分位於該旋轉軸區之該晶圓;以及

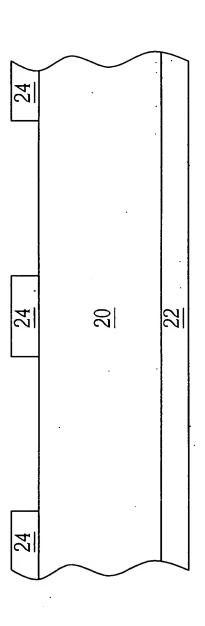
由該晶圓之一第二表面去除位於該二穿透區之該晶圓直至穿透該晶圓。

- 8. 如申請專利範圍第7項所述之方法,其中位於該旋轉軸區之該晶圓係利用蝕刻方式加以去除。
- 9. 如申請專利範圍第7項所述之方法,該中位於該二穿透區之該晶圓係利用蝕刻方式加以去除。
- 10. 如申請專利範圍第7項所述之方法,其中於去除位於該穿透區之該晶圓時,該晶圓之該第一表面係利用一黏著層貼附於一負載載具上。
- 11. 如申請專利範圍第10項所述之方法,另包含有於去除位於該穿透區之該晶圓後進行一移除該黏著層之步驟。

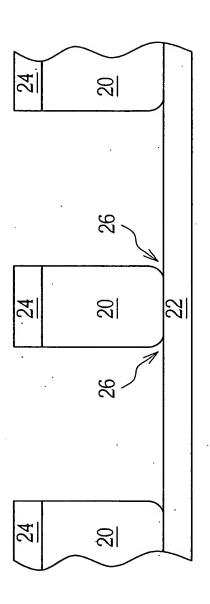
十一、圖式:



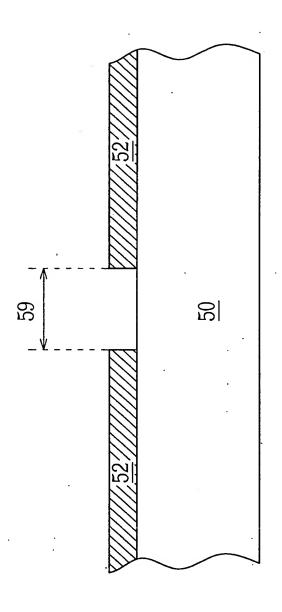
第1圖



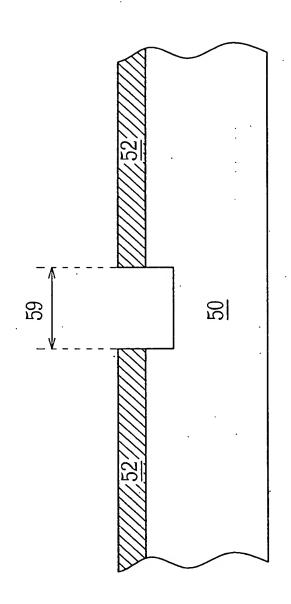
第2圖



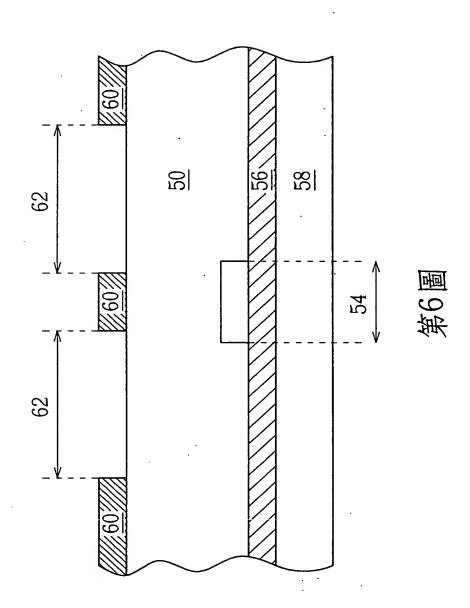
第3圖

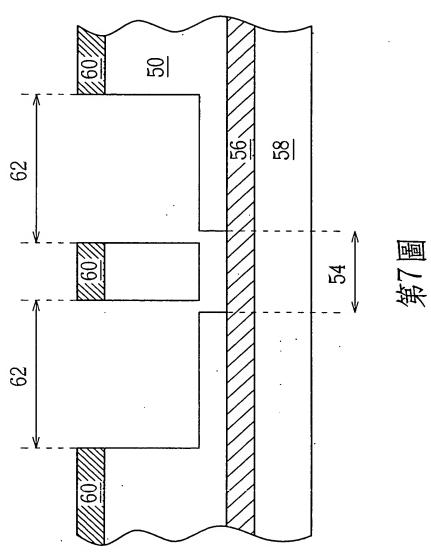


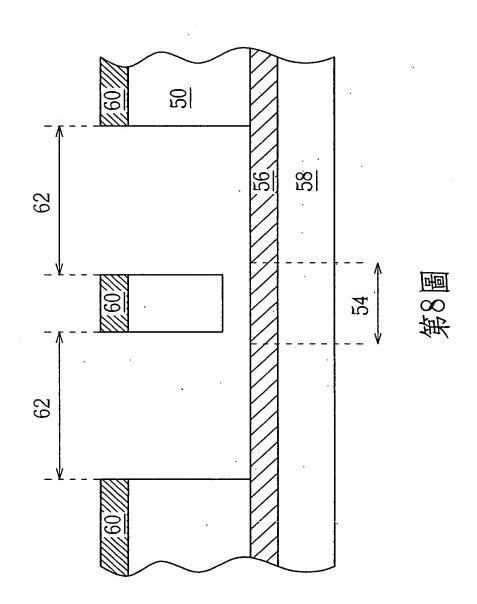
第4圖



第5圖







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